



# SIMATIC IPC647D Technical Information

www.siemens.com/rack-pc

Image shows device with maximum configuration. Differences to your configuration may appear.



# SIMATIC IP647D Overview front



### SIMATIC IPC647D Overview rear





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### SIMATIC IPC647D / IPC847D Processors characteristics



	Processor name	Processor number	Number of physical cores (Cores)	Number of virtual cores (Threads)	Clock rate / Clock rate with Turbo Boost (GHz)	Cache (MByte)	Turbo Boost 2.0	Virtualization (VT-x / VT-d)	64 Bit (EM64T)	iamt 9.0	ECC
inside XEON	Xeon	E3-1268L v3	4	8	2,3 / 3,3	8	V	✓ <i> </i> ✓	✓	✓	√(*
inside" CORE"15	Core i5	i5- 4570TE	2	4	2,7 / 3,3	4	V	√   √	~	~	V
inside CORE i3	Core i3	i3- 4330TE	2	2	2,4 / -	4	-	✓ / -	~	-	$\checkmark$

The Intel Xeon E3 offers a optimized performance / watt and supports ECC memory – the comparable Intel Core i7 processors do not

### Passmark 7 Rating IPC647C/847C versus IPC647D/847D





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### SIMATIC IPC647D/ IPC847D Designed and tested for the 24 / 7 Operation





#### **Optimized Cooling Concept**

- Air flow is designed for constant heat removal
- Speed-controlled and ball bearing mounted fans

Full processing power up to 50°C operating environment – no Throttling

additional fan



#### **Dust Protection**

- Controlled overpressure ventilation protects IPC for dust intrusion
- · Filter mat replaceable without tools

Reliability and constant performance also at harsh industrial environment

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### SIMATIC IPC647D/ IPC847D Designed and tested for the 24 / 7 Operation





### Drive Mounting

- Rubber-cushioned mounting of the drives
- Shock and vibration protection during operation

Reliability and data availability also under high vibration and shock stress

#### Redundant Power Supply

• Redundant power supply is replaceable during operation



Reliability and system availability for the non-stop operation

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![](_page_6_Picture_13.jpeg)

### Metal Housing

- Robust aluminum housing offers mechanical ruggedness and electromagnetic shielding
- Very low emission of electromagnetic radiation
  - High mechanical ruggedness and EMC compliance for a maximum in operational reliability

# SIMATIC IPC647D/ IPC847D Easy to service for facilitated maintenance & expansion

![](_page_7_Picture_1.jpeg)

![](_page_7_Picture_2.jpeg)

![](_page_7_Picture_3.jpeg)

#### Easy to service Housing

- Opening of the housing with just one screw
- Components are easy to access for replacement or expansion
- Replacement of the dust protection and front fan without any tools

Reduction of service and maintenance time

![](_page_7_Picture_9.jpeg)

![](_page_7_Picture_10.jpeg)

### Great Expandability

- Up to 4 PCI(e) expansion card with IPC647D
- 11 PCI(e) expansion slots with IPC847D
  - Easy expandability for greater flexibility

# Internal USB 3.0 – port with optional interlocking

- Software-Dongle
- Recipes and configurations

![](_page_7_Picture_18.jpeg)

![](_page_7_Picture_19.jpeg)

# SIMATIC IPC647D/IPC847D Additional options for the use as Industrial Server

![](_page_8_Picture_1.jpeg)

![](_page_8_Picture_2.jpeg)

with Vmware ESXi Server operating system

![](_page_8_Picture_4.jpeg)

![](_page_8_Picture_5.jpeg)

### SIMATIC IPC647D/IPC847D New options

![](_page_9_Picture_1.jpeg)

![](_page_9_Picture_2.jpeg)

#### Hardware RAID controller

with Zero Maintenance Cache Protection (ZMCP) Module

#### Low operating costs

 no additional costs for installation, monitoring, maintenance, disposal or exchange of batteries (Battery Backup Units (BBUs))

#### High data security

of in the RAID-Cache saved data when it comes to electricity failure

- Replaces lithium ion accumulators
- State of battery charge does not have to be monitored
- No shutting down for battery change necessary
- Secured data is being saved for up to 10 years
- Does only need a few minutes instead of some hours for loading

![](_page_9_Picture_14.jpeg)

#### AC UPS-power supply \* combines UPS functions with PC power supply

#### High data security

- in case of an interruption of the source, the UPS functions will set up instantaneously and feed the load with energy taken from its battery pack
- secure shut down a windows operating system

### Low operating costs with

Maintenance-free lead-tin battery

- The equipped CYCLON cells are based on a special lead-tin alloy which results in a service life of up to 10 years in stand-by mode
- Due to its low self-discharge a fully charged battery pack can be stored for up to 1 year

![](_page_9_Picture_23.jpeg)

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\* only IPC847D

# SIMATIC IPC647D / IPC847D Turbo Boost 2.0 (Xeon CPU)

![](_page_10_Picture_1.jpeg)

Depending on the CPU core utilization and the temperature levels (TDP and ambient temperature), CPUs which support Turbo Boost technology automatically increase the clock frequency of CPU cores in steps of 133 MHz (bins). Additionally the graphics frequency increases.

The Intel Xeon Processor E3-1268L v3 offers these Turbo Boost values

- Processor frequency: 2.3 GHz Max. frequency (Turbo):
- Graphics frequency: 350 MHz Max. frequency (Turbo):

3.3 GHz

1000 MHz

Burst Mode: Increased over clocking of the cores by utilizing the thermal budget (TDP) of the CPU for a short time

![](_page_10_Picture_9.jpeg)

![](_page_10_Picture_10.jpeg)

**Base Frequencies** 

Idle mode

### SIMATIC Rack PC RAID1 vs. RAID5: Overview

![](_page_11_Picture_1.jpeg)

### RAID 1: Data mirroring

#### Process

Data is being duplicated and written in parallel on two HDDs

#### **Advantages**

- Same data set is secured automatically
- If one HDD fails, the system is still working
   → No data is lost
- → Simple data recovery

#### Disadvantage

 Only the capacity of one HDD can be effectively used

![](_page_11_Picture_11.jpeg)

### RAID 5: Data striping with parity\*

#### Process

Data is being written block by block (striping) on all HDDs (with check sums on all HDDs)

#### **Advantages**

- Very efficient with small data blocks
- High data transfer rates when reading
- If one HDD fails, the system is still working
   → No data is lost
- → Cost-effective possibility for redundant data storage on several HDDs with the available memory volume efficiently used

#### Disadvantages

- At least three HDDs are required
- Slower data transfer rates when writing compared to RAID1 as the error correction data (parity bits) has to be calculated

### Additional HDD as hot spare in RAID configurations\*

#### Process

Hot spare disks are preparatory HDDs that are kept on active standby for use when a HDD in a RAID configuration fails

#### Advantages

- Automatic integration of the hot spare disk into the RAID configuration and start of the rebuild process in case of failure of a contained HDD
  - → Maximum data availability

### SIMATIC Rack PC RAID1 vs. RAID5: Feature comparison

![](_page_12_Picture_1.jpeg)

RAID features	<b>RAID1</b> (Mirroring)	<b>RAID5*</b> (Striping with parity)	
Minimum amount of HDDs	2 (2x 1 TByte)	3 (3x 1 TByte)	
Data security	Failure of one HDD	Failure of one HDD	
Read performance	Medium	High	
Write performance	Medium	Low	
Capacity utilization of HDDs	50% (1 TByte)	67% - 94% (2 TByte)	
Benefits	High data availability in case of a single HDD failure	Optimal utilization of the used HDD capacity with high fault tolerance	
Typical applications	Real-time critical applications, e.g. databases	Storage of large data volumes, e.g. archiving	

# SIMATIC IPC647D / IPC847D ECC – RAM for increased Data Integrity and System Stability

![](_page_13_Picture_1.jpeg)

![](_page_13_Picture_2.jpeg)

![](_page_13_Figure_3.jpeg)

#### ECC - RAM

- Optional ECC RAM protects for damage and variation of data processing and transmission
- ECC RAM reduces clearly the probability of critical data failures and system crashes

Maximum data integrity and system stability for a reliable data handling and storage

# SIMATIC IPC647D / IPC847D Multi-Monitoring (Intel Hybrid Multi-Monitor Support)

![](_page_14_Picture_1.jpeg)

![](_page_14_Figure_2.jpeg)

• 2x via graphics card (as an option)

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# SIMATIC IPC647D Graphics card (new)

![](_page_15_Picture_1.jpeg)

NVIDIA Quadro graphics processor: Overall frame buffer: Width of the memory interface: Memory bandwidth: Max. VGA resolution: Max. DVI resolution: Max. DP resolution:

Graphics slot: Form factor: Interfaces:

Max. power: Cooling: Scope of supply in configurator :

API:

48 CUDA parallel computing cores<sup>1)</sup> 1024 MByte 64 bit 14 Gbit/s 2048 x 1536 @ 85Hz 1920 x 1200 @ 60 Hz 2560 x 1600 @ 60 Hz

PCI-Express x16 69,37 mm x 167,64 mm (ATX bracket, 1 slot) 2x DVI-D or 2x VGA

19,5 W Activ with fan / fan monitoring over DiagBase / DiagMonitor DMS-59 to DVI-D adapter or DVI to VGA adapter

OpenGL 4.1 / DirectX 11 / Shader Model 5.0

![](_page_15_Picture_10.jpeg)

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Ingenuity for life

<sup>1)</sup> CUDA, the parallel calculation architecture from NVIDIA, enables a significant increase in computing performance, using the performance of the graphics processor.

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# **SIMATIC IPC647D** Graphics card (old)

![](_page_16_Picture_1.jpeg)

### **NVIDIA Quadro NVS 300 graphics card**

NVIDIA Quadro graphics processor: Overall frame buffer: Width of the memory interface: Memory bandwidth: Max. digital monitor resolution at 60 Hz:

Graphics slot: Form factor: Interfaces:

Max. power: Cooling: Scope of supply in configurator:

API:

16 CUDA parallel computing cores<sup>1)</sup> 512 MByte 64 bit 12.6 Gbit/s 2560 x 1600

PCI-Express x16 69.37 mm x 167.64 mm (ATX bracket, 1 slot) 2x DVI-D or 2x VGA

17 W Fanless DMS-59 to DVI-D adapter or DVI to VGA adapter

OpenGL 3.3 DirectX 10.1 Shader Model 4.1

![](_page_16_Picture_11.jpeg)

2x VGA- oder 2x DVI-D-Adapter

<sup>1)</sup> CUDA, the parallel calculation architecture from NVIDIA, enables a significant increase in computing performance, using the performance of the graphics processor.

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Migration C→D	Ingenu	ity for life			
IPC647C		IPC647D			
Installation compatibility					
Housing measures	No changes				
Housing design	No major changes	$\checkmark$			
Interface compatibility					
Number of expansion slots	No changes				
Type of expansion slots	PCI and PC-Express				
Installation slots front	2x low-profile removable frame / 1x (slim) for DVD±R/RW				
Installation slot s internaly	CF-Drive not aviilable anymore				
External interfaces	<ul> <li>2x DisplayPort V1.2 and DVI-I instead of 1x DVI-I</li> <li>4x USB 3.0 &amp; 3x USB 2.0 instead of 7x USB 2.0</li> <li>COM2 &amp; LPT as Slot (option) instead COM2 &amp; LPT onboard</li> </ul>				
Software compatibility					
Software	Applications can still be used; maybe new drivers need to be loaded				
• Windows XP 7 / Windows Server 2003 R2 (32 bit) / Windows Server 2008 (32 bit ) not available anymore					
Miscellaneous compatibilit	ty	ш			
Image	New chipset, therefore not image compatible				

# **SIMATIC IPC647** Migrat

![](_page_17_Picture_4.jpeg)

![](_page_18_Picture_1.jpeg)

Housing, Chipset, Processors, Main Memory, and Expansion Slots				
Housing	<ul> <li>19" Rack, 2U</li> <li>Rugged all-metal housing, painted outside and coated inside</li> <li>Lockable front flap for access protection</li> <li>Prepared for telescopic slides</li> <li>For horizontal mounting</li> </ul>			
Chipset	Intel DH82C226 PCH (C226)			
Processors	<ul> <li>Intel® Xeon™ E3-1268L v3 4C/8T, 2.3 (3.3) GHz, 8 MByte Cache, Turbo Boost 2.0, Virtualization (VT-x/-d)-Technology, iAMT 9.0</li> <li>Intel® Core™ i5-4570TE 2C/4T, 2.7 (3.3) GHz, 4 MByte Cache, Turbo Boost 2.0, Virtualization (VT-x/-d)-Technology, iAMT 9.0</li> <li>Intel® Core™ i3-4330TE 2C/4T, 2.4 GHz, 4 MByte Cache, Virtualization (VT-x)-Technology</li> </ul>			
Main Memory	<ul> <li>from 2 GByte DDR3-1600 SDRAM, Dual Channel support, Expandable up to 32 GByte<sup>1)</sup></li> <li>ECC from 8 GByte optional</li> </ul>			
Expansion Slots (all 312 mm)	<ul> <li>PCI-/ PCIe-Slots (2 PCI, 2 PCI-Express)</li> <li>2 x PCI</li> <li>2 x PCI-Express x16 (8 Lane) Gen 3</li> </ul>	<ul> <li>PCI-Express Slots (4 PCI-Express)</li> <li>1 x PCI-Express x16 (4 Lane) Gen 3</li> <li>1 x PCI-Express x16 (4 Lane) Gen 2</li> <li>1 x PCI-Express x16 (4 Lane) Gen 3</li> <li>1 x PCI-Express x16 (8 Lane) Gen 3</li> </ul>	<ul> <li>PCI-Express Slots (2 PCI-Express)</li> <li>1 x PCI-Express x16 (4 Lane) Gen 3</li> <li>1 x PCI-Express x16 (4 Lane) Gen 2</li> </ul>	

<sup>1)</sup> For configurations up to 4 GByte, the visible memory could be reduced to ca. 3.5 GByte or less (when using 32 bit operating systems).

![](_page_19_Picture_1.jpeg)

<sup>1)</sup> Operating system if ordered is installed on SSD

Installation Slots and D	Drives
Installation Slots	<ul> <li>Internal: 2x 3.5"</li> <li>Front: 2x low-profile removable frame; 1x slim for ODD or 1x 2,5" SSD</li> </ul>
Hard disks (HDD), SATA / SAS 3.5", NCQ Solid-state drive (SSD) SATA 2.5"	<ul> <li>Mounted internally:</li> <li>1x 240 GB SSD <sup>1</sup>)</li> <li>Internal installation in drive holder (shock and vibration-damped) (up to 5g/0.5g):</li> <li>1 x 500 GB HDD</li> <li>1 x 1 TB HDD</li> <li>2 x 1 TB HDD</li> <li>2 x 1 TB HDD, RAID1, 1 TB (2 x 1 TB HDD, mirror disks), RAID controller onboard</li> <li>Installed on the front in the low-profile removable drive bay (hot swapping in RAID configurations):</li> <li>1 x 500 GB HDD</li> <li>1 x 1 TB HDD</li> <li>2 x 1 TB HDD</li> <li>2 x 1 TB HDD</li> <li>1 x 500 GB HDD</li> <li>1 x 500 GB HDD</li> <li>1 x 1 TB HDD</li> <li>2 x 1 TB HDD</li> <li>3 x 240 GB SSD</li> <li>RAID1, 1 TB (2 x 1 TB HDD, mirror disks), RAID controller onboard</li> <li>RAID1, 1 TB (2x 1 TB HDD, mirror disks), PCIe x8 RAID controller incl. ZMCP module; (2 slots occupied)</li> <li>RAID1, 240 GB (2 x 240 GB SSD, mirror disks), RAID controller onboard</li> </ul>
Optical Drive	<ul> <li>without</li> <li>DVD±R/RW (slim)</li> </ul>

![](_page_20_Picture_1.jpeg)

Graphics, Power Supplies and Operating Systems			
Graphics	<ul> <li>Onboard Intel HD Graphics 4600 integrated in the processor with Dynamic Video Memory with up to 1.7 GByte VGA, DVI and DisplayPort with up to 3840 x 2160 pixels at 60 Hz image refresh rate and 32 bit colors</li> <li>PCI-Express graphics card in PCIe x16 slot (as an option) NVIDIA NVS 315 graphics controller with 1 GByte graphics memory Dual Head: 2x VGA or 2x DVI-D with up to 2048 x 1536 pixels at 60 Hz image refresh rate and 32 bit colors</li> </ul>		
Power Supplies	<ul> <li>AC: 100-240 V, 400 W, wide range</li> <li>AC redundant: 2x 100-240 V, 350 W, wide range (as an option)</li> </ul>		
Short-time voltage interruption	• Max. 20 ms		
Operating Systems	<ul> <li>without</li> <li>Pre-installed and activated (and enclosed on Restore DVD):</li> <li>Windows 7 Ultimate SP1, 32 Bit, MUI <sup>1</sup>)</li> <li>Windows 7 Ultimate SP1, 64 Bit, MUI <sup>1</sup>)</li> <li>Windows 10 Enterprise 2015 LTSB, 64 Bit, MUI <sup>1</sup>)</li> <li>Windows 10 Enterprise 2016 LTSB, 64 Bit, MUI <sup>1</sup>)</li> <li>Windows Server 2008 R2 Standard Edition SP1 incl. 5 Clients, 64 Bit, MUI <sup>1</sup>)</li> <li>Windows Server 2012 R2 Standard Edition incl. 5 Clients, 64 Bit, MUI <sup>1</sup>)</li> <li>Windows Server 2016 Standard Edition incl. 5 Clients, 64 Bit, MUI <sup>1</sup>)</li> </ul>		

<sup>1)</sup> Multi Language User Interface, 5 languages: English, German, French, Spanish, Italian

![](_page_21_Picture_1.jpeg)

Interfaces	Interfaces				
Ethernet	<ul> <li>2x Gigabit Ethernet (IE/PN), RJ 45, teaming capable</li> <li>Intel Ethernet Controller WGi217LM und WGi210IT</li> <li>Wake on LAN (WoL) support</li> </ul>				
PROFIBUS DP/MPI	12 Mbit/s, isolated, compatible with CP 5622, (optional)				
PROFINET	10/100 Mbit/s with integral 3-port switch, CP1616-compatible (optional)				
DisplayPort	• 2x (V1.2)				
DVI-I	• 1x				
VGA	Via cable adapter (as an option)				
USB 3.0 (high current)	<ul> <li>Front: 1x</li> <li>Rear: 2x</li> <li>Internal: 1x</li> </ul>				
USB 2.0 (high current)	<ul> <li>Front: 1x</li> <li>Rear: 2x</li> </ul>				
Serial	<ul> <li>1x COM1 (V.24)</li> <li>1x COM2 (V.24) (as an option)</li> </ul>				
Parallel	1x LPT (EPP/ECP) (as an option)				
PS/2	2x (Keyboard, Mouse)				
Audio	1x Line Out, 1x Micro				

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![](_page_22_Picture_1.jpeg)

Electromagnetic Comp	Electromagnetic Compatibility (EMC) / climatic ambient conditions				
Noise emissions	<ul> <li>EN 61000-6-3, EN 61000-6-4</li> <li>EN 61000-3-2 Class D; EN 61000-3-3</li> <li>CISPR 22</li> <li>EN 55022 Class B</li> <li>FCC Class A</li> </ul>				
Immunity against conducted interference on the supply lines	<ul> <li>± 2 kV; according to IEC 61000-4-4; Burst</li> <li>± 1 kV; according to IEC 61000-4-5; Surge symm.</li> <li>± 2 kV; according to IEC 61000-4-5; Surge asymm.</li> </ul>				
Noise immunity on signal lines	<ul> <li>± 2 kV; according to IEC 61000-4-4; Burst, length &gt; 30 m</li> <li>± 1 kV; according to IEC 61000-4-4; Burst, length &lt; 30 m</li> <li>± 2 kV, according to IEC 61000-4-5; Surge, length &gt; 30 m</li> </ul>				
Immunity against discharge of static electricity	<ul> <li>± 6 kV contact discharge; according to IEC 61000-4-2</li> <li>± 8 kV discharge to air; according to IEC 61000-4-2</li> </ul>				
Immunity against high- frequency radiation	<ul> <li>10 V/m, 80 MHz to 1 GHz, 80% AM; according to IEC 61000-4-3</li> <li>3 V/m, 1.4 to 2 GHz, 80% AM; according to IEC 61000-4-3</li> <li>10 V, 150 kHz to 80 MHz; according to IEC 61000-4-6</li> </ul>				
Immunity against magnetic fields	<ul> <li>100 A/m, 50/60 Hz; according to IEC 61000-4-8</li> </ul>				
Temperature	• 0 °C to +50 °C acc. to IEC 60068-2-2; IEC 60068-2-1; IEC 60068-2-14 ( limitations s. operating instruction)				

![](_page_23_Picture_1.jpeg)

System-tested SIMATIC	C Software, Approvals, Dimensions and Weight	
SIMATIC Software	<ul> <li>STEP 7</li> <li>WinAC / Software Controller S7-1500</li> <li>WinCC</li> <li>SOFTNET</li> </ul>	
Safety regulations	<ul> <li>IEC60950-1 / EN60950-1 / UL60950-1</li> <li>CSA C22.2 No. 60950-1-07</li> </ul>	
Approvals	<ul> <li>CE</li> <li>cULus (UL 60950)</li> <li>KC</li> <li>RCM (C-Tick)</li> <li>EAC</li> <li>BIS</li> </ul>	<ul> <li>Marine approvals (only with SSD)</li> <li>Lloyds Register (LR)</li> <li>American Bureau of Shipping (ABS)</li> <li>Bureau Veritas (BV)</li> <li>Det Norske Veritas / Germanischer Lloyd (DNV GL)</li> <li>Korean Register of Shipping (KR)</li> <li>Nippon Kaiji Kyokai (NK)</li> <li>Registro Italiano Navale (RINA)</li> <li>China Classification Society (CCS)</li> </ul>
CE Mark	<ul> <li>Operation in residential, office, and industrial areas</li> <li>Interference emission: EN 61000-6-3:2007 + A1:2011</li> <li>Noise immunity: EN 61000-6-2:2005</li> </ul>	
EU Directives	• RoHS	
Installation dimensions	430 mm x 88 mm x 444 mm (W x H x D)	
Weight	From 10 kg	

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### SIMATIC IPC647D Information

![](_page_24_Picture_1.jpeg)

![](_page_24_Picture_2.jpeg)

Rumpf-MLFB	6AG4112-2	
Ordering system	<ul><li>A&amp;D Mall:</li><li>Online configurator:</li></ul>	http://www.siemens.de/automation/mall http://www.siemens.com/ipc-configurator
Support	Aftersales:	http://www.siemens.com/asis http://www.siemens.com/automation/support-request

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